

ENGINEERING	PRODUCT SPECIFICATION	SPEC.NO.:	SPCI002E
DEPT.	For CI02 Series Connector System	PAGE:	1/3

1. SCOPE:

This specification contains the test requirement of subject connectors when tested under the condition and procedure with terminals crimped on the specified maximum size wire

2. APPLICABLE STANDARDS:

MIL - STD - 202 MIL - STD - 1344 Methods for test of connectors for electronic equipment

Test methods for electrical connectors

3. APPLICABLE SERIES NO.: CI02 Series

4. SHAPE, CONSTRUCTION AND DIMENSIONS

See attached drawings

5. MATERIALS

See attached drawings

6. ACCOMMODATED P.C.BOARD

6.1 Thickness: 1.6 mm (.063")

6.2 P.C. Board Layout: See attached drawings

CVILUX.CORI 2004.10.01

REVIEWED: <u>Alex</u> APPROVED: <u>David</u> VERIFIED: <u>Jason</u>.



ENGINEERING	PRODUCT SPECIFICATION	SPEC.NO.:	SPCI002E
DEPT.	For CI02 Series Connector System	PAGE:	2/3

7. ELECTRICAL PERFORMANCE:

	ITEM	TEST CONDITION	REQUIREMENT
7.1	Rated current and voltage		2A 250V AC (r.m.s.)
7.2	Contact resistance	Dry circuit of DC 20 mV max., 100 mA max.	Less than 20 mΩ
7.3	Dielectric strength	When applied AC 800 V 1 minute between adjacent terminal	No change
7.4	Insulation resistance	When applied DC 500 V between adjacent terminal or ground	More than $1000 \text{M}\Omega$

8. MECHANICAL PERFORMANCE:

	ITEM	TEST CONDITION	REQUIREMENT
8.1	Wire size	Specified wire size	Accepts AWG#24~#28
8.2	Terminal crimp Tensile	When crimped AWG#24 size wire	More than 3.0 Kgf
	strength	When crimped AWG#26 size wire	More than 2.0 Kgf
		When crimped AWG#28 size wire	More than 1.3 Kgf
8.3	Terminal insertion force	Insertion speed 25± 3 mm per minute into housing	Less than 500 gram
8.4	Contact retaining force in insulator	Retention speed 25± 3 mm per minute from housing	More than 1.5 Kgf

9. ENVIRONMENTAL PERFORMANCE:

	ITEM	TEST CONDITION	REQUIREMENT
9.1	Temperature rise	Then carried the rated current	30°C max.
9.2	Solder ability	Soldering time: 5 ± 0.5 second Soldering pot: 230 ± 5°C	Minimum: 90% of immersed area
9.3	Resistance to soldering heat	Soldering time: 5 ± 0.5 second Soldering pot: 260 ± 5°C	No damage
9.4	Heat aging	85 ± 2°C , 96 hours	No damage
9.5	Humidity	40 ± 2 °C , 90-95% RH , 96 hours measurement must be taken within 30 min. after tested	Appearance: No damage Contact resistance: Less than twice of initial Dielectric strength: To pass para 7-3



ENGINEERING	PRODUCT SPECIFICATION	SPEC.NO.:	SPCI002E
DEPT.	For CI02 Series Connector System	PAGE:	3/3

	ITEM	TEST CONDITION	REQUIREMENT
9.6	Temperature cycling	One cycle consists of: (1)-55 -3 °C, 30 min.	Appearance: No damage Contact resistance:
		(2)Room temp. 10-15 min. (3) 85 +3 °C, 30 min. (4)Room temp. 10-15 min.	Less than twice of initial
9.7	Salt spray	Temperature: 35 ± 3°C Solution: 5 ± 1% Spray time: 48 ± 4 hours Measurement must be taken after water rinse	Appearance: No damage Contact resistance: Less than twice of initial

10. AMBIENT TEMPERATURE RANGE: -25 to +85°C